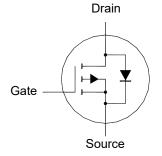
WTR02P100US-HAF

P-Channel Enhancement Mode MOSFET

Features

 Halogen and Antimony Free(HAF), RoHS compliant





1.Gate 2.Drain 3.Source TO-252 Plastic Package

Key Parameters

Parameter	Value	Unit	
-BV _{DSS}	20	V	
R _{DS(ON)} Max	10 @ -V _{GS} = 10 V 13 @ -V _{GS} = 4.5 V	mΩ	
-V _{GS(th)} typ	0.8	V	
Q _g typ	102 @ -V _{GS} = 10 V	nC	

Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage		-V _{DS}	20	V
Gate-Source Voltage		V _G s	± 12	V
Drain Current	T _c = 25°C T _c = 100°C	-I _D	65 40.9	А
Peak Drain Current, Pulsed 1)		-I _{DM}	180	Α
Single-Pulse Avalanche Current		-l _{AS}	33	Α
Single-Pulse Avalanche Energy 2)		Eas	54	mJ
Power Dissipation T _c = 25°C		P _D	48	W
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to + 150	°C	

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	Rejc	2.6	°C/W
Thermal Resistance from Junction to Ambient 3)	R _{0JA}	36	°C/W

 $^{^{1)}}$ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.



Dated: 15/01/2021 Rev: 01

 $^{^{2)}}$ Limited by $T_{J(MAX)},$ starting T_J = 25 °C, L = 0.1 mH, R_g = 25 $\Omega,$ -I $_D$ = 33 A, -V $_{GS}$ = 10 V.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

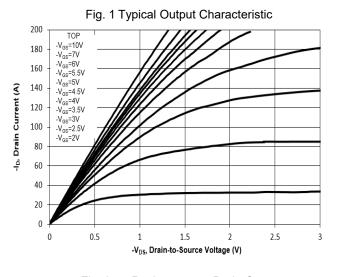
WTR02P100US-HAF

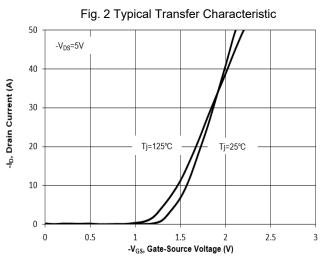
Characteristics at Ta = 25°C unless otherwise specified

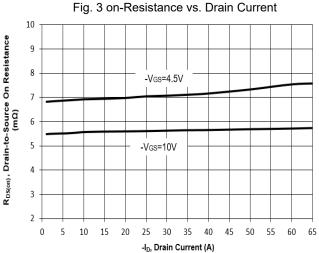
Characteristics at T _a = 25°C unless otherwise specified Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS	5,111001		1,17.	WIGA.	O i iii
Drain-Source Breakdown Voltage					
at $-I_D = 250 \mu A$	-BV _{DSS}	20	-	-	V
Drain-Source Leakage Current	-I _{DSS}	_	_	1	μA
at -V _{DS} = 16 V	1000				μ, ,
Gate Leakage Current at V _{GS} = ± 12 V	Igss	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $-I_D = 250 \mu A$	-V _{GS(th)}	0.3	-	1	V
Drain-Source On-State Resistance					
at $-V_{GS} = 10 \text{ V}$, $-I_D = 15 \text{ A}$	R _{DS(on)}	-	7.6	10 13	mΩ
at -V _{GS} = 4.5 V, -I _D = 8 A DYNAMIC PARAMETERS		-	_	13	
Gate resistance at V _{DS} = 0 V, f = 1 MHz	Rg	-	2	-	Ω
Forward Transconductance at $-V_{DS} = 5 V$, $-I_{D} = 8 A$	g fs	-	38.6	-	S
Input Capacitance at - V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	Ciss	-	4596	-	pF
Output Capacitance at $-V_{DS} = 10 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	Coss	-	546	-	pF
Reverse Transfer Capacitance at $-V_{DS} = 10 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	Crss	-	449	-	pF
Total Gate Charge at -V _{GS} = 10 V, -V _{DS} = 10 V, -I _D = 15 A	Q_g	-	102	-	nC
at $-V_{GS}$ = 4.5 V, $-V_{DS}$ = 10 V, $-I_D$ = 15 A Gate-Source Charge		-	47	-	
at -V _{GS} = 10 V, -V _{DS} = 10 V, -I _D = 15 A	Q _{gs}	-	9	-	nC
Gate-Drain Charge at -V _{GS} = 10 V, -V _{DS} = 10 V, -I _D = 15 A	Q_{gd}	-	13	-	nC
Turn-On Delay Time at $-V_{DD}$ = 10 V, $-V_{GS}$ = 10 V, $-V_{DD}$ = 15 A, $-V_{GS}$ = 3.3 $-\Omega$	t _{d(on)}	-	28	-	nS
Turn-On Rise Time at -V _{DD} = 10 V, -V _{GS} = 10 V, -I _D = 15 A, R _g = 3.3 Ω	t _r	-	67	-	nS
Turn-Off Delay Time at -V _{DD} = 10 V, -V _{GS} = 10 V, -I _D = 15 A, R _g = 3.3 Ω	$t_{d(off)}$	-	41	-	nS
Turn-Off Fall Time at -V _{DD} = 10 V, -V _{GS} = 10 V, -I _D = 15 A, R _g = 3.3 Ω	t _f	-	5	-	nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at -Is = 1 A, V _{GS} = 0 V	-V _{SD}	-	-	1.2	V
Body-Diode Continuous Current	-Is	-	-	65	Α
Body-Diode Continuous Current, Pulsed	-I _{SM}	-	-	180	Α
Body Diode Reverse Recovery Time at -Is = 15 A, di/dt = 100 A / µs	t _{rr}	-	17	-	nS
Body Diode Reverse Recovery Charge at -Is = 15 A, di/dt = 100 A / µs	Qrr	-	7.8	-	nC

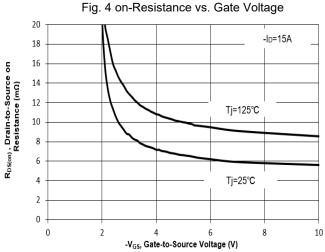


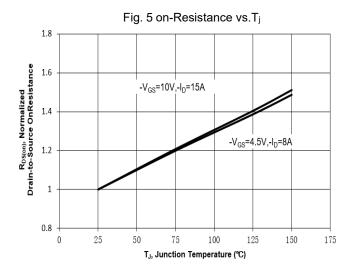
Electrical Characteristics Curves

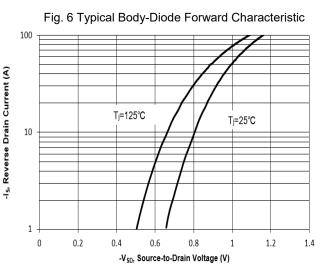






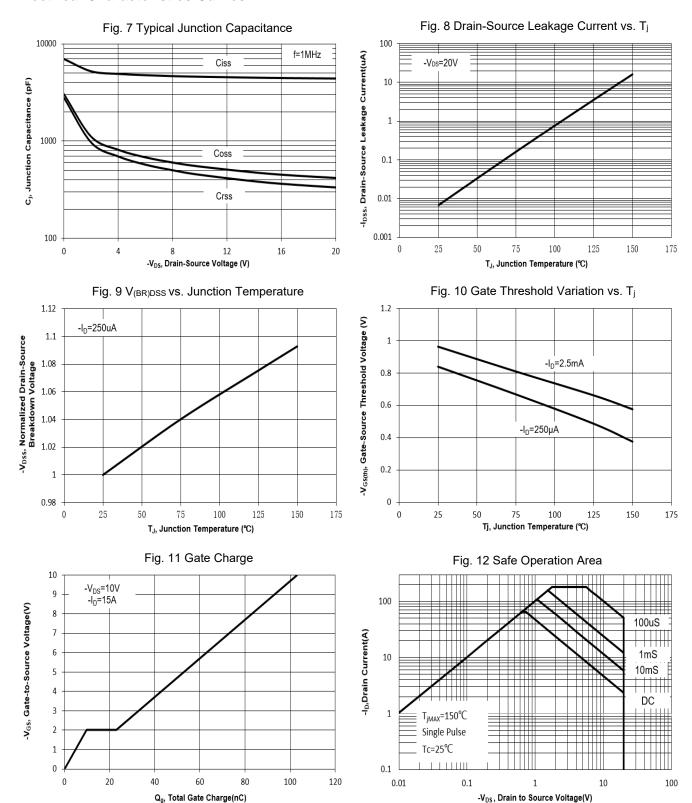






(R

Electrical Characteristics Curves





4/8

Electrical Characteristics Curves

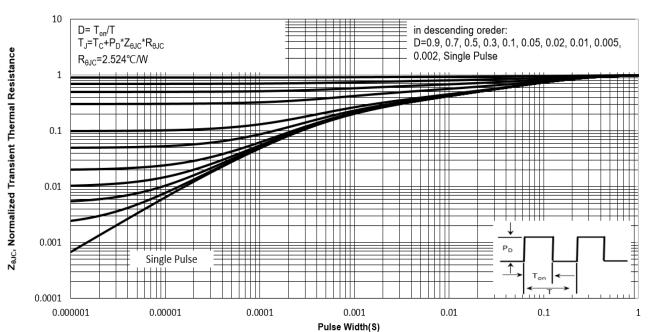
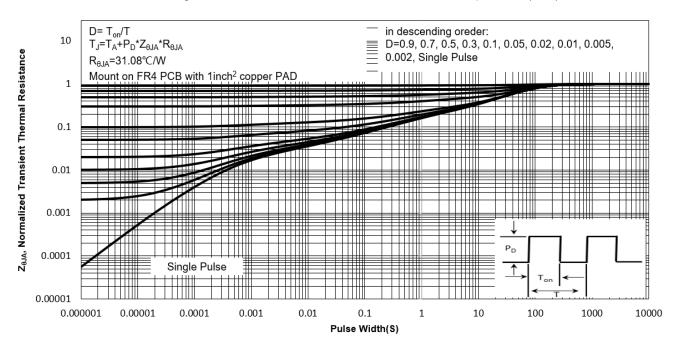


Fig. 13 Normalized Maximum Transient Thermal Impedance(zeuc)

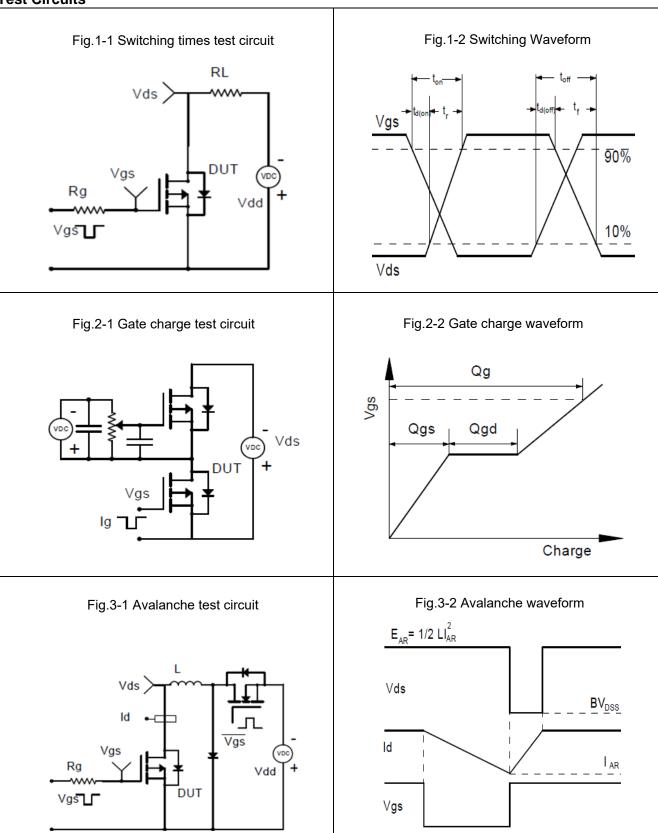






WTR02P100US-HAF

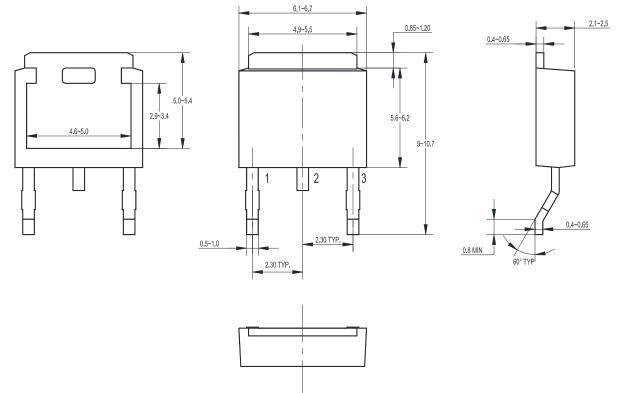
Test Circuits



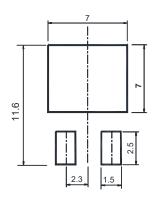


Package Outline (Dimensions in mm)

TO-252



Recommended Soldering Footprint



Packing information

i acking iiiio	g information					
Package ^{Ta}	Tape Width	Pitch		Reel Size		Per Reel Packing Quantity
	(mm)	mm	inch	mm	inch	rei Neel Fackling Qualitity
TO-252	12	8 ± 0.1	0.315 ± 0.004	330	13	2,500

Marking information

" TR02P100US " = Part No.

" ***** " = Date Code Marking

Font type: Arial



7/8



IMPORTANT NOTICE

Our company and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes to improve product design, functions and reliability without further notice to this document and any product described herein.

Statements described herein regarding the reliability and suitability of products is for illustrative purposes only. Products specifically described herein are not authorized for use as critical components in life support devices, automobile, military, aviation or aerospace only with the written approval of our company.

The information contained herein is presented only as guidance for product use. No license to any intellectual property rights is granted under this document. No responsibility is assumed by our company for any infringement of patents or any other intellectual property rights of third party that may result from the use of the product.

